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March 2015

FDD8447L 40V N-Channel PowerTrench® MOSFET **40V**, **50A**, **8.5m** Ω

Features

- Max $r_{DS(on)}$ = 8.5m Ω at V_{GS} = 10V, I_D = 14A
- Max $r_{DS(on)}$ = 11.0m Ω at V_{GS} = 4.5V, I_D = 11A
- Fast Switching
- RoHS Compliant



General Description

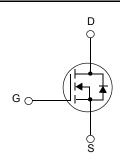
This N-Channel MOSFET has been produced using Fairchild Semiconductor's proprietary PowerTrench® technology to deliver low $r_{DS(on)}$ and optimized BV_{DSS} capability to offer superior performance benefit in the application.

Applications

- Inverter
- Power Supplies







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DS}	Drain to Source Voltage	40	V
V_{GS}	Gate to Source Voltage	±20	V
	Drain Current -Continuous (Package limited) T _C = 25°C	50	
	-Continuous (Silicon limited) T _C = 25°C	57	^
ΙD	-Continuous T _A = 25°C (Note 1a)	15.2	_ A
	-Pulsed	100	
I _S	Max Pulse Diode Current	100	Α
E _{AS}	Drain-Source Avalanche Energy (Note 3)	153	mJ
	Power Dissipation T _C = 25°C	44	
P_D	T _A = 25°C (Note 1a)	3.1	W
	T _A = 25°C (Note 1b)	1.3	
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.8	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (N	lote 1a)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (N	lote 1b)	96	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD8447L	FDD8447L	D-PAK(TO-252)	13"	16mm	2500 units

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter Test Conditions		Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	40			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		35		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 32V, V_{GS} = 0V$			1	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{GS} = 0V$			±100	nA

On Characteristics (Note 2)

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1.0	1.9	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		-5		mV/°C
r _{DS(on)}		V _{GS} = 10V, I _D = 14A		7.0	8.5	
	Static Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 11A$		8.5	11.0	mΩ
		V _{GS} = 10V, I _D = 14A, T _J =125°C		10.4	14.0	
9 _{FS}	Forward Transconductance	V _{DS} = 5V, I _D = 14A		58		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	1970	pF
C _{oss}	Output Capacitance		250	pF
C _{rss}	Reverse Transfer Capacitance		150	pF
R_g	Gate Resistance	f = 1MHz	1.27	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		12	21	ns
t _r	Rise Time	$V_{DD} = 20V, I_{D} = 1A$ $V_{GS} = 10V, R_{GEN} = 6\Omega$	12	21	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} - 10V, K _{GEN} - 652	38	61	ns
t _f	Fall Time		9	18	ns
$Q_{g(TOT)}$	Total Gate Charge, V _{GS} = 10V	-V _{DD} = 20V, I _D = 14A -V _{GS} = 10V	37	52	nC
$Q_{g(TOT)}$	Total Gate Charge, V _{GS} = 5V		20	28	nC
Q _{gs}	Gate to Source Gate Charge	V _{GS} - 10V	6		nC
Q_{gd}	Gate to Drain "Miller" Charge		7		nC

Drain-Source Diode Characteristics

I_S	Maximum Continuous Drain-Source Diode	Maximum Continuous Drain-Source Diode Forward Current (N			2.6	Α
V_{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = 14A	(Note 2)	8.0	1.2	V
t _{rr}	Reverse Recovery Time	1 - 14A di/dt - 100/	V/o	22		ns
Q _{rr}	Reverse Recovery Charge	I _F = 14A, di/dt = 100A/μs		11		nC

Notes:

Reuc is guaranteed by design while Reua is determined by the user's board design.

a. 40°C/W when mounted on a 1 in2 pad of 2 oz copper

b. 96°C/W when mounted on a minimum pad.

^{2:} Pulse Test: Pulse Width < $300\mu\text{s},$ Duty cycle < 2.0%.

^{3:} Starting TJ = 25° C, L = 1mH, IAS = 17.5A, VDD = 40V, VGS = 10V.

Typical Characteristics

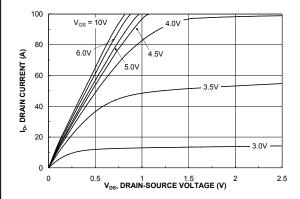


Figure 1. On-Region Characteristics

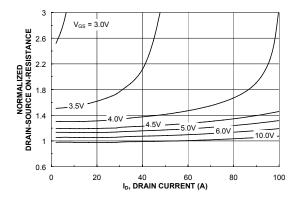


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

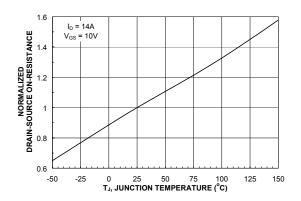


Figure 3. On-Resistance Variation with Temperature

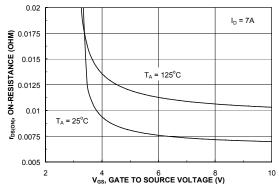


Figure 4. On-Resistance Variation with Gate-to-Source Voltage

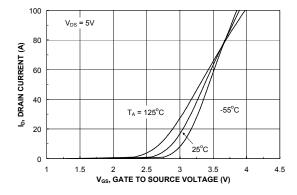


Figure 5. Transfer Characteristics

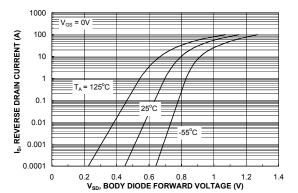


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature

Typical Characteristics

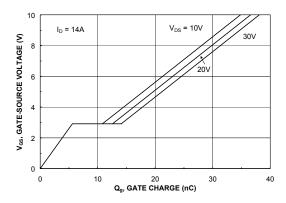


Figure 7. Gate Charge Characteristics

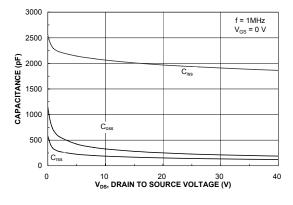


Figure 8. Capacitance Characteristics

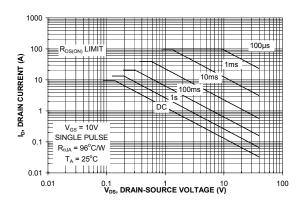


Figure 9. Maximum Safe Operating Area

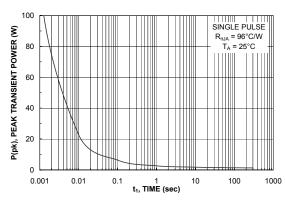


Figure 10. Single Pulse Maximum Power Dissipation

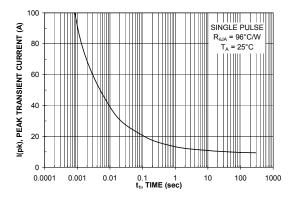


Figure 11. Single Pulse Maximum Peak Current

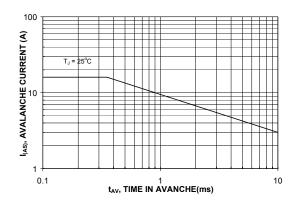


Figure 12. Unclamped Inductive Switching Capability

Typical Characteristics

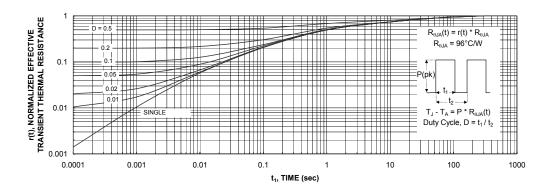
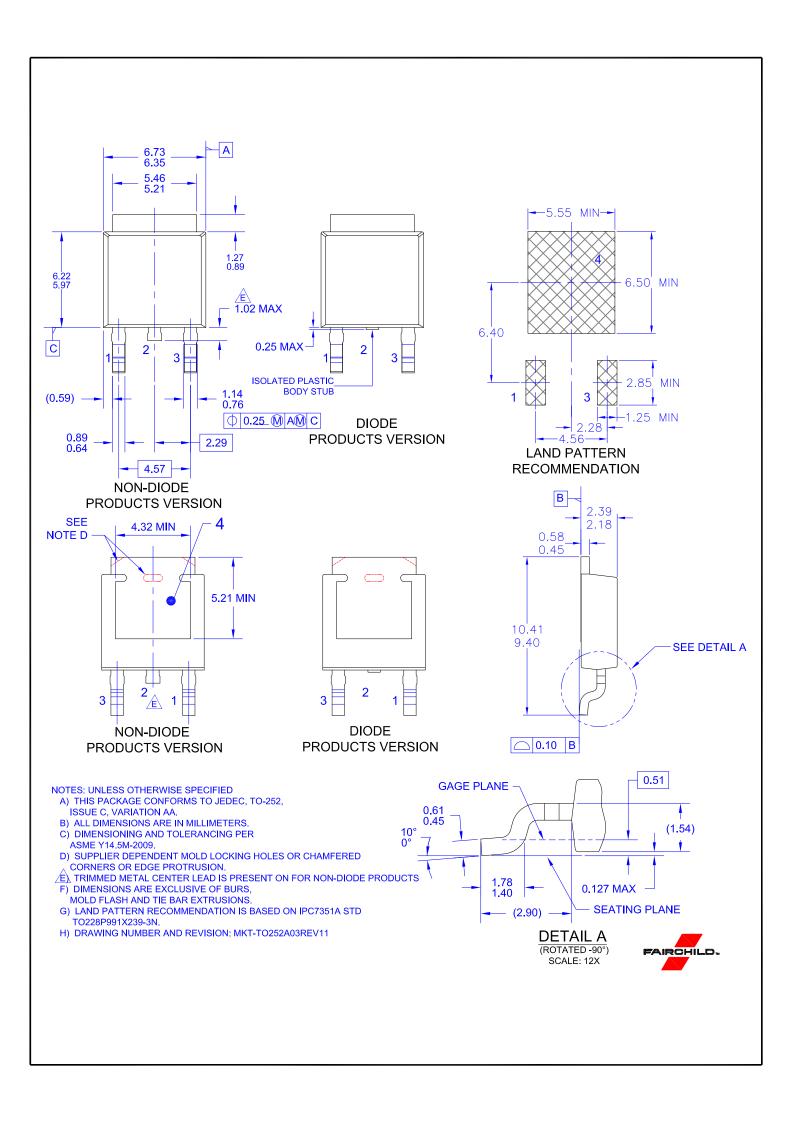


Figure 13. Transient Thermal Response Curve

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.



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